# **Power MOSFET** 60 V, 8.9 m $\Omega$ , 48 A, Single N–Channel

#### Features

- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Q<sub>G</sub> and Capacitance to Minimize Driver Losses
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (	T <sub>J</sub> = 25°C	unless otherw	vise noted)		
Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V <sub>DSS</sub>	60	V
Gate-to-Source Voltage			V <sub>GS</sub>	±20	V
Continuous Drain Current $R_{\theta JC}$ (Notes 1 & 3)	Steady State	$T_{C} = 25^{\circ}C$	I <sub>D</sub>	48	Α
		$T_C = 100^{\circ}C$		34	
Power Dissipation $R_{\theta JC}$ (Note 1)		$T_C = 25^{\circ}C$	PD	42	W
		$T_C = 100^{\circ}C$		21	1
Continuous Drain Current $R_{\theta JA}$ (Notes 1, 2 & 3)	Steady	$T_A = 25^{\circ}C$	I <sub>D</sub>	15	Α
		$T_A = 100^{\circ}C$		10	1
Power Dissipation $R_{\theta JA}$ (Notes 1 & 2)	State	$T_A = 25^{\circ}C$	PD	4.0	W
		$T_A = 100^{\circ}C$		2.0	1
Pulsed Drain Current	$T_A = 25^{\circ}$	<sup>2</sup> C, t <sub>p</sub> = 10 μs	I <sub>DM</sub>	250	Α
Operating Junction and Storage Temperature			T <sub>J</sub> , T <sub>stg</sub>	-55 to 175	°C
Source Current (Body Diode)			ا <sub>S</sub>	25	Α
Single Pulse Drain–to–Source Avalanche Energy $(I_{L(pk)} = 3 A)$			E <sub>AS</sub>	104	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

#### MAVINALINA DATINICO (T 0500

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain) (Note 1)	$R_{ extsf{ heta}JC}$	3.6	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	37	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

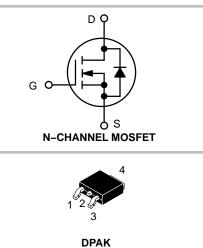
- 2. Surface-mounted on FR4 board using a 650 mm<sup>2</sup>, 2 oz. Cu pad.
- 3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



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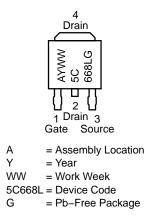
#### www.onsemi.com

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
60 V	8.9 mΩ @ 10 V	49 A
00 V	12.8 mΩ @ 4.5 V	49 A



CASE 369C STYLE 2

#### MARKING DIAGRAM **& PIN ASSIGNMENT**



#### **ORDERING INFORMATION**

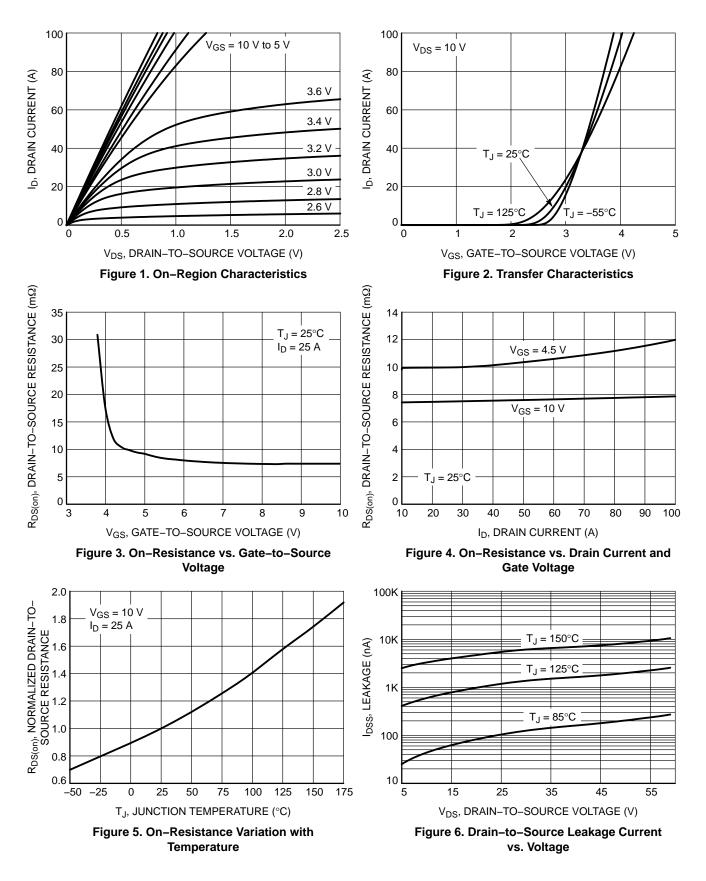
See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

## **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

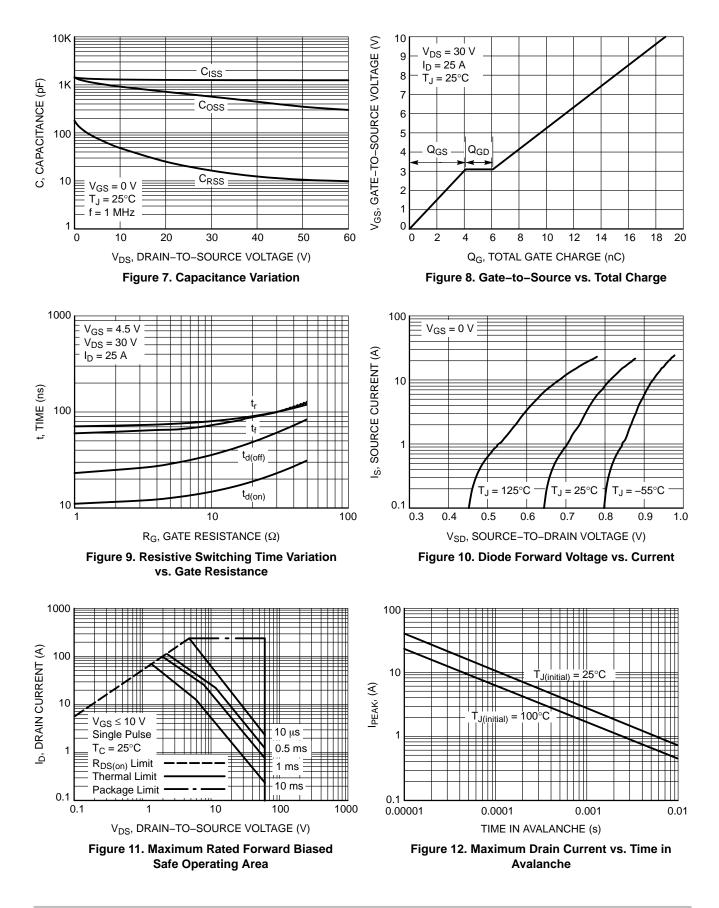
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>				27		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V$ , $T_J = 25^{\circ}C$				10	μΑ
		T <sub>J</sub> = 125°C			250	1	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = 20 V				100	nA
ON CHARACTERISTICS (Note 4)							-
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_D = 50 \ \mu A$		1.2		2.1	V
Negative Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				4.8		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	$V_{GS}$ = 10 V, I <sub>D</sub> = 25 A $V_{GS}$ = 4.5 V, I <sub>D</sub> = 25 A			7.4	8.9	mΩ
					10.2	12.8	1
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 25 A			60		S
CHARGES, CAPACITANCES AND GATE RE	SISTANCES						
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V, f = 1.0 MHz, V <sub>DS</sub> = 25 V			1300		pF
Output Capacitance	C <sub>oss</sub>				580		
Reverse Transfer Capacitance	C <sub>rss</sub>				18		1
Total Gate Charge		V <sub>GS</sub> = 4.5 V		8.7		nC	
		$I_{\rm D} = 25  {\rm A}^2$	V <sub>GS</sub> = 10 V		18.7		1
Threshold Gate Charge	Q <sub>G(TH)</sub>	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 30 V, I <sub>D</sub> = 25 A			2.4		nC
Gate-to-Source Charge	Q <sub>GS</sub>				4.1		1
Gate-to-Drain Charge	Q <sub>GD</sub>				2.0		1
Plateau Voltage	V <sub>GP</sub>				3.1		V
SWITCHING CHARACTERISTICS (Note 5)							
Turn–On Delay Time	t <sub>d(on)</sub>	$V_{GS}$ = 4.5 V, $V_{DS}$ = 30 V, I <sub>D</sub> = 25 A, R <sub>G</sub> = 2.5 Ω			12		ns
Rise Time	t <sub>r</sub>				74		1
Turn–Off Delay Time	t <sub>d(off)</sub>				26		
Fall Time	t <sub>f</sub>				62		1
DRAIN-SOURCE DIODE CHARACTERISTIC	S				-		
Forward Diode Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 20 A	$T_J = 25^{\circ}C$		0.87	1.2	V
			T <sub>J</sub> = 125°C		0.76		1
Reverse Recovery Time	t <sub>RR</sub>	V <sub>GS</sub> = 0 V, dl <sub>S</sub> /dt = 100 A/μs, I <sub>S</sub> = 25 A			32		ns
Charge Time	ta				15		1
Discharge Time	tb				16		1
Reverse Recovery Charge	Q <sub>RR</sub>				20		nC

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

#### **TYPICAL CHARACTERISTICS**



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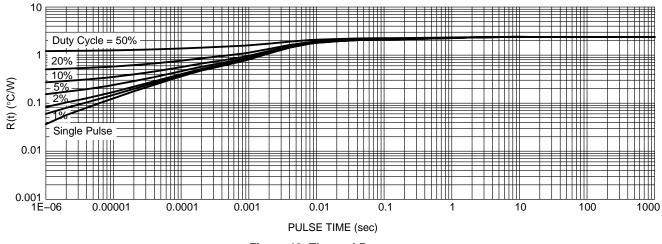


Figure 13. Thermal Response

#### **ORDERING INFORMATION**

Order Number	Package	Shipping <sup>†</sup>
NTD5C668NLT4G	DPAK (Pb–Free)	2500 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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